

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re patent application of

Sang Hyun YI et al

Serial No.

Filed: January 4, 2002

For: SEMICONDUCTOR DEVICE HAVING NO CRACKS IN ONE OR MORE LAYERS UNDERLYING A METAL LINE LAYER AND METHOD OF MANUFACTURING THE SAME

PRELIMINARY AMENDMENT

Assistant Commissioner for Patents
Washington, D.C. 20231

Sir:

Prior to initial examination on the merits, please amend the application identified above as follows:

IN THE DRAWINGS

Kindly substitute the attached sheet "3/17" depicting Figures 3A and 3B for the sheet designated "3/17" appended to the application. Figure 3A, second occurrence on this sheet of drawing, has been corrected to read — — Fig. 3B — —.

REMARKS

This drawing amendment is presented to correct an obvious clerical error.

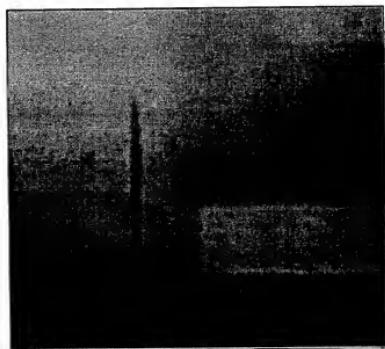
Respectfully submitted,

January 4, 2002
Date


Eugene M. Lee
Registration No. 32,039

THE LAW OFFICES OF EUGENE M. LEE, P.L.L.C.
1101 Wilson Boulevard, Suite 2000
Arlington, Virginia 22209
Telephone: (703) 525-0978

FIG.3A BACKGROUND ART



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FIG.3B BACKGROUND ART

